General Description

The SJ40N015 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

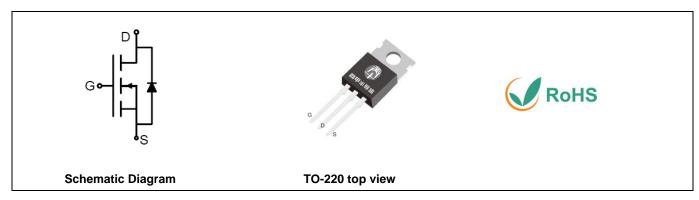
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- Load switch
- Uninterruptible power supply
- Hard switched and high frequency circuits

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	40	٧
R _{DS(ON)_TYP}	2.1	mΩ
I _D	223	A
Q _G	139	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJ40N015	SJ40N015	TO-220	Tube	\	\	1000 Pcs

Table 1. Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	40	V
V _G S	Gate-Source Voltage (V _{DS} =0V)	±20	V
l-	Drain Current-Continuous(Tc=25°C)	223	А
l _D	Drain Current-Continuous(Tc=100°C)	141	А
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	892	А
D ₋	Maximum Power Dissipation(Tc=25°C)	227	W
P_D	Maximum Power Dissipation(T _C =100°C)	91	W
Eas	Avalanche energy (Note 2)	1024	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
$R_{ hetaJC}$	Thermal Resistance, Junction-to-Case		0.55	°C/W



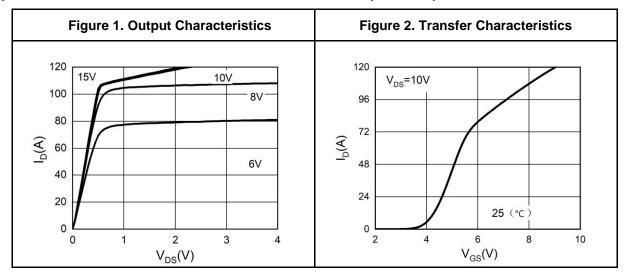
Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

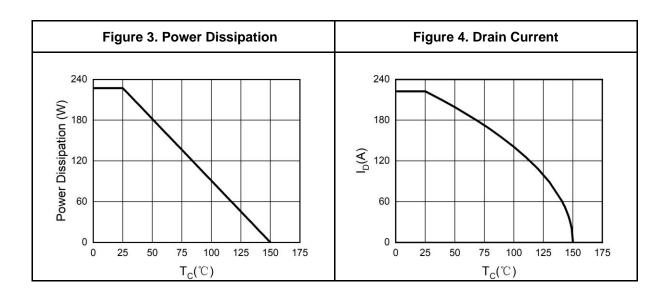
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	40			V
	Zara Oata Valta va Daria Oursant	V _{DS} =40V, V _{GS} =0V T _J =25°C			1	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V T _J =125℃			100	μΑ
Igss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	2		4	V
G FS	Forward Transconductance	V _{DS} =5V, I _D =20A		30		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A T _J =25°C		2.1	2.7	mΩ
Dynamic Charac	teristics					
Ciss	Input Capacitance			8327		pF
Coss	Output Capacitance	V _{DS} =20V,V _{GS} =0V, f=1.0MHz		753		pF
Crss	Reverse Transfer Capacitance			578		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		0.9		Ω
Switching Paran	neters					
t _{d(on)}	Turn-on Delay Time			20.4		nS
tr	Turn-on Rise Time	V _{GS} =10V, V _{DS} =20V,		17.8		nS
t _{d(off)}	Turn-Off Delay Time	R_L =1Ω, R_{GEN} =3Ω		46.4		nS
t _f	Turn-Off Fall Time			15		nS
Q_g	Total Gate Charge			139		nC
Q_gs	Gate-Source Charge	V _{GS} =10V, V _{DS} =20V, I _D =20A		36		nC
Q_gd	Gate-Drain Charge			38.4		nC
Source-Drain Die	ode Characteristics					
I _{SD}	Source-Drain Current (Body Diode)				223	А
V_{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =20A, dI/dt=500A/μs		36.3		ns
Q _{rr}	Reverse Recovery Charge	I _F =20A, dI/dt=500A/μs		38		nC

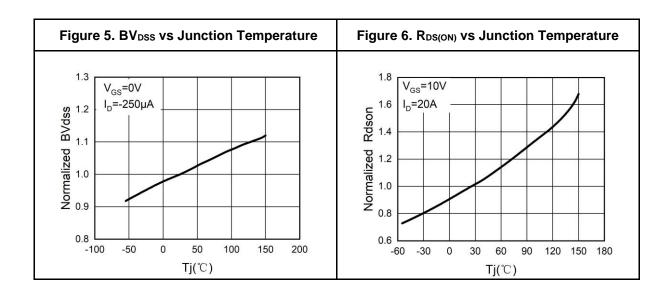
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: T_J=25°C,V_{DD}=40V,V_G=10V, Rg=25 Ω , L=0.5mH. Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

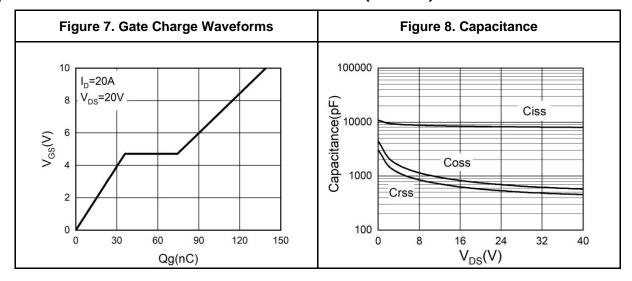
Typical Electrical And Thermal Characteristics (Curves)

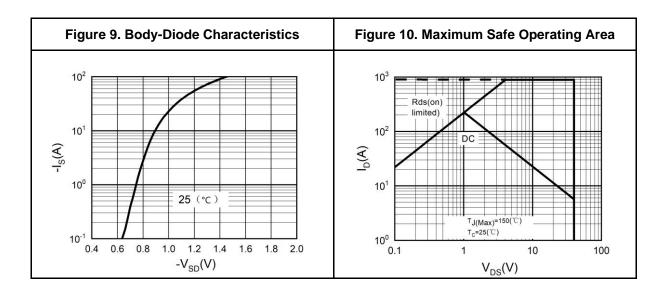






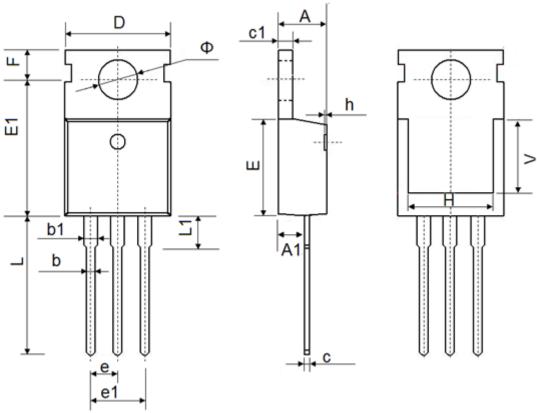
Typical Electrical And Thermal Characteristics (Curves)







TO-220 Package Information



Cumbal	Dimen	sions In Millimeters	Dim	ensions In Inches	
Symbol	Min.	Max.	Min.	Max	
А	4.300	4.700	0.169	0.185	
A1	2.200	2.600	0.087	0.102	
b	0.700	0.950	0.028	0.037	
b1	1.170	1.410	0.046	0.056	
С	0.450	0.650	0.018	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.600	10.400	0.378	0.409	
E	8.8500	9.750	0.348	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.750	14.300	0.502	0.563	
L1	2.850	3.950	0.112	0.156	
V	7.500	REF.	0.295 REF.		
Ф	3.400	4.000	0.134	0.157	

Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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